



PATENT
0649-0791P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:	YAMAGUCHI et al.	Conf.:	7851
Appl. No.:	09/901,662	Group:	1714
Filed:	July 11, 2001	Examiner:	K. WYROZEBSKI LEE
For:	MOLDING COMPOSITION		

*OK to
enter
2-24-2004*

REPLY UNDER 37 C.F.R. § 1.116

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 17, 2004
(Tuesday after Holiday)

Sir:

In reply to the Office Action dated October 15, 2003, the period for response having been extended one (1) month to February 15, 2004, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This Reply contains amendments to the claims and Remarks.

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